

**RESPONSE UNDER 37 C.F.R. § 1.116  
EXPEDITED PROCEDURE  
GROUP ART UNIT 1795**

Docket Number  
36856.1455

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hiroyuki KANBARA et al.  Application No.: 10/596,000  Confirmation No.: 1561  Filing or 371(c) Date: January 17, 2007  Title: METHOD FOR FORMING THICK FILM PATTERN, METHOD FOR MANUFACTURING ELECTRONIC COMPONENT AND PHOTOLITHOGRAPHY PHOTOSENSITIVE PASTE	Art Unit: 1795   Examiner: A. Eoff
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**AMENDMENT**

DO NOT ENTER: /A.E./

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

07/07/2008

Sir:

In response to the Office Action dated April 2, 2008, please amend the above-identified application as follows:

☐ **Amendments to the Specification** begin on page       of this paper.

☒ **Amendments to the Claims** are reflected in the listing of the claims which begins on page **2** of this paper.

☐ **Amendments to the Drawings** begin on page of this paper and include an attached replacement sheet. An **Appendix** including the amended drawing figures is attached following page       of this paper.

☒ **Remarks/Arguments** begin on page **6** of this paper.

Please note, if a box is not checked, then no corresponding amendment is being made.